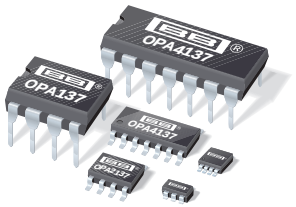
BURR-BROWN®



OPA137
OPA2137
OPA4137

LOW COST
FET-INPUT OPERATIONAL AMPLIFIERS
*Micro*Amplifier™ Series

FEATURES

- FET INPUT: I_B = 5pA
- LOW OFFSET VOLTAGE: 1.5mV
- WIDE SUPPLY RANGE: ±2.25V to ±18V
- LOW QUIESCENT CURRENT: 220µA/channel
- EXCELLENT SPEED/POWER: 1MHz
- INPUT TO POSITIVE SUPPLY
- *Micro*SIZE PACKAGES: SOT-23-5, MSOP-8
- SINGLE, DUAL, AND QUAD

APPLICATIONS

- STRAIN GAGE AMPLIFIER
- PHOTODETECTOR AMPLIFIER
- PRECISION INTEGRATOR
- BATTERY-POWERED INSTRUMENTS
- TEST EQUIPMENT
- ACTIVE FILTERS

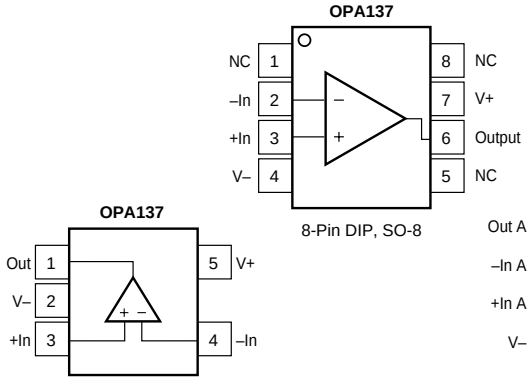
DESCRIPTION

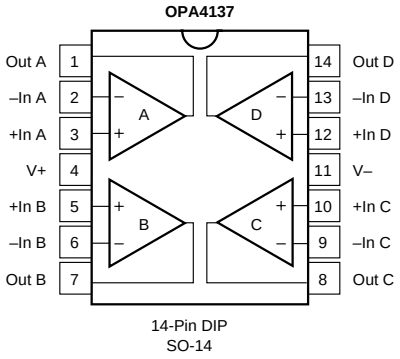
OPA137 series FET-input operational amplifiers are designed for low cost and miniature applications. In addition to small size (SOT-23-5 and MSOP-8 packages), they provide low input bias current (5pA), low quiescent currrent (220µA/channel), and high open-loop gain (94dB).

Either single (+4.5V to +36V) or dual (±2.25 to ±18V) supplies can be used. The input common-mode voltage range includes the positive supply—suitable for many single-supply applications. Single, dual, and quad versions have identical specifications for maximum design flexibility.

OPA137 op amps are easy to use and free from phase inversion and overload problems found in some FET-input amplifiers. High performance, including linearity, is maintained as the amplifiers swing to their specified limits. In addition, the combination of high slew rate (3.5V/µs) and wide bandwidth (1MHz) provide fast settling time assuring good dynamic response. Dual and quad designs feature completely independent circuitry for lowest crosstalk and freedom from interaction.

The single (OPA137) packages are the tiny 5-lead SOT-23-5 surface mount, SO-8 surface mount, and 8-pin DIP. The dual (OPA2137) comes in the miniature MSOP-8 surface mount, SO-8 surface mount, and 8-pin DIP packages. The quad (OPA4137) packages are the SO-14 surface mount and the 14-pin DIP. All are specified from –40°C to +85°C and operate from –55°C to +125°C. A SPICE macromodel is available for design analysis.





International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd., Tucson, AZ 85706 • Tel: (520) 746-1111 • Twx: 910-952-1111
Internet: http://www.burr-brown.com/ • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

PDS-1438A
Printed in U.S.A. August, 1998
SBOS089

SPECIFICATIONS: V_S = ±15V

At T_A = +25°C, R_L = 10kΩ connected to ground, unless otherwise noted.
Boldface limits apply over the specified temperature range, T_A = –40°C to +85°C.

PARAMETER		CONDITION	OPA137N, U, P OPA2137E, U, P OPA4137U, P			OPA137NA, UA, PA OPA2137EA, UA, PA OPA4137UA, PA			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
OFFSET VOLTAGE									
Input Offset Voltage	V_{OS}			±1.5	±3		±2.5	±10	mV
T_A = –40°C to +85°C				±2.5	**±7**		±3.5	**±15**	mV
vs Temperature	dV_{OS}/dT	T_A = –40°C to +85°C		±15			*		µV/°C
vs Power Supply	PSRR	V_S = ±3V to ±18V		±90	±250		*	*	µV/V
T_A = –40°C to +85°C					**±250**			*	µV/V
Channel Separation (dual, quad)		dc		0.6			*		µV/V
INPUT BIAS CURRENT		V_{CM} = 0V							
Input Bias Current	I_B			±5	±100		*	*	pA
vs Temperature				See Typical Curve			*		
Input Offset Current	I_{OS}			±2	±50		*	*	pA
NOISE									
Input Voltage Noise, f = 0.1 to 10Hz				2			*		µVp-p
Input Voltage Noise Density, f = 1kHz	e_n			45			*		nV/√Hz
Current Noise Density, f = 1kHz	i_n			1.2			*		fA/√Hz
INPUT VOLTAGE RANGE									
Common-Mode Voltage Range	V_{CM}		(V–) + 3		(V+)	*		*	V
Common-Mode Rejection Ratio	CMRR	V_{CM} = –12V to 15V							
OPA137, OPA2137			76	84		70	*		dB
OPA4137			74	84		70	*		dB
T_A = –40°C to +85°C		V_{CM} = –12V to 15V							
OPA137, OPA2137			**72**			**70**			dB
OPA4137			**70**			**70**			dB
INPUT IMPEDANCE									
Differential				10^{10} || 1			*		Ω || pF
Common-Mode				10^{12} || 2			*		Ω || pF
OPEN-LOOP GAIN									
Open-Loop Voltage Gain	A_{OL}	V_O = –13.8V to 13.9V	86	94		*	*		dB
T_A = –40°C to +85°C		V_O = –13.8V to 13.9V	**86**			*			dB
FREQUENCY RESPONSE									
Gain-Bandwidth Product	GBW			1			*		MHz
Slew Rate	SR	G = 1		3.5			*		V/µs
Settling Time, 0.1%		G = 1, 10V Step, C_L = 100pF		8			*		µs
0.01%		G = 1, 10V Step, C_L = 100pF		10			*		µs
Overload Recovery Time		V_{IN} • G = V_S		1			*		µs
Total Harmonic Distortion + Noise	THD+N	G = 1, f = 1kHz, 3.5Vrms		0.05			*		%
OUTPUT									
Voltage Output	V_{OUT}		(V–) + 1.2		(V+) – 1.1	*		*	V
T_A = –40°C to +85°C			**(V–) + 1.2**		**(V+) – 1.1**	*		*	V
Short-Circuit Current	I_{SC}			–25/+60			*		mA
Capacitive Load Drive	C_{LOAD}			1000			*		pF
POWER SUPPLY									
Specified Operating Range	V_S			±15			*		V
Operating Voltage Range									
Dual Supplies			±2.25[1]		±18	*		*	V
Single Supply			+4.5		+36	*		*	V
Quiescent Current	I_Q	I_O = 0		±220	±270		*	*	µA
T_A = –40°C to +85°C		I_O = 0			**±375**			*	µA
TEMPERATURE RANGE									
Specified Range			–40		+85	*		*	°C
Operating Range			–55		+125	*		*	°C
Storage Range			–55		+125	*		*	°C
Thermal Resistance	θ_{JA}								
SOT-23-5 Surface Mount				200			*		°C/W
MSOP-8 Surface Mount				150			*		°C/W
SO-8 Surface Mount				150			*		°C/W
8-Pin DIP				100			*		°C/W
SO-14 Surface Mount				100			*		°C/W
14-Pin DIP				80			*		°C/W

* Specifications the same as OPA137N, U, P.

NOTE: (1) At minimum power supply voltage inputs must be biased above ground in accordance with common-mode voltage range restrictions—see "Operating Voltage" discussion.

ABSOLUTE MAXIMUM RATINGS[1]

Supply Voltage, V+ to V–	36V
Input Voltage	(V–) –0.7V to (V+) +0.7V
Input Current	2mA
Output Short-Circuit[2]	Continuous
Operating Temperature	–55°C to +125°C
Storage Temperature	–55°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	300°C

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum ratings for extended periods may affact device reliability. (2) Short circuit to ground, one amplifier per package.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

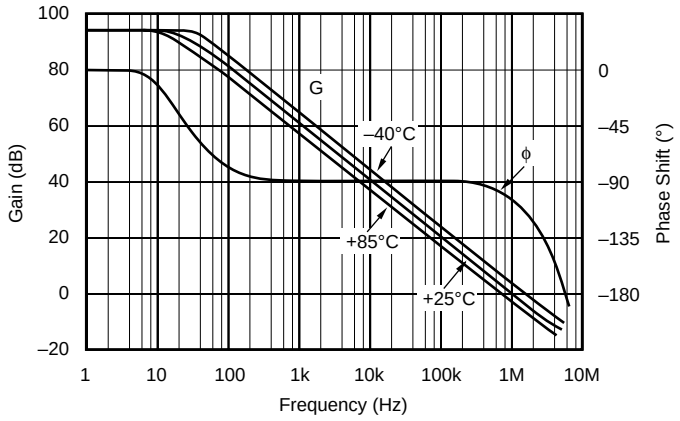
PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER[1]	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER[2]	TRANSPORT MEDIA
Single						
OPA137N	5-Lead SOT-23-5 Surface Mount	331	–40°C to +85°C	E37[3]	OPA137N/250	Tape and Reel
"	"	"	"	"	OPA137N/3K	Tape and Reel
OPA137NA	5-Lead SOT-23-5 Surface Mount	331	–40°C to +85°C	E37[3]	OPA137NA/250	Tape and Reel
"	"	"	"	"	OPA137NA/3K	Tape and Reel
OPA137U	SO-8 Surface Mount	182	–40°C to +85°C	OPA137U	OPA137U	Rails
"	"	"	"	"	OPA137U/2K5	Tape and Reel
OPA137UA	SO-8 Surface Mount	182	–40°C to +85°C	OPA137UA	OPA137UA	Rails
"	"	"	"	"	OPA137UA/2K5	Tape and Reel
OPA137P	8-Pin DIP	006	–40°C to +85°C	OPA137P	OPA137P	Rails
OPA137PA	8-Pin DIP	006	–40°C to +85°C	OPA137PA	OPA137PA	Rails
Dual						
OPA2137E	MSOP-8 Surface Mount	337	–40°C to +85°C	E37[3]	OPA2137E/250	Tape and Reel
"	"	"	"	"	OPA2137E/2K5	Tape and Reel
OPA2137EA	MSOP-8 Surface Mount	337	–40°C to +85°C	E37[3]	OPA2137EA/250	Tape and Reel
"	"	"	"	"	OPA2137EA/2K5	Tape and Reel
OPA2137U	SO-8 Surface Mount	182	–40°C to +85°C	OPA2137U	OPA2137U	Rails
"	"	"	"	"	OPA2137U/2K5	Tape and Reel
OPA2137UA	SO-8 Surface Mount	182	–40°C to +85°C	OPA2137UA	OPA2137UA	Rails
"	"	"	"	"	OPA2137UA/2K5	Tape and Reel
OPA2137P	8-Pin DIP	006	–40°C to +85°C	OPA2137P	OPA2137P	Rails
OPA2137PA	8-Pin DIP	006	–40°C to +85°C	OPA2137PA	OPA2137PA	Rails
Quad						
OPA4137U	SO-14 Surface Mount	235	–40°C to +85°C	OPA4137U	OPA4137U	Rails
"	"	"	"	"	OPA4137U/2K5	Tape and Reel
OPA4137UA	SO-14 Surface Mount	235	–40°C to +85°C	OPA4137UA	OPA4137UA	Rails
"	"	"	"	"	OPA4137UA/2K5	Tape and Reel
OPA4137P	14-Pin DIP	010	–40°C to +85°C	OPA4137P	OPA4137P	Rails
OPA4137PA	14-Pin DIP	010	–40°C to +85°C	OPA4137PA	OPA4137PA	Rails

NOTES: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book. (2) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 3000 pieces of "OPA137NA/3K" will get a single 3000-piece Tape and Reel. For detailed Tape and Reel mechanical information, refer to Appendix B of Burr-Brown IC Data Book. (3) Grade information is marked on the reel.

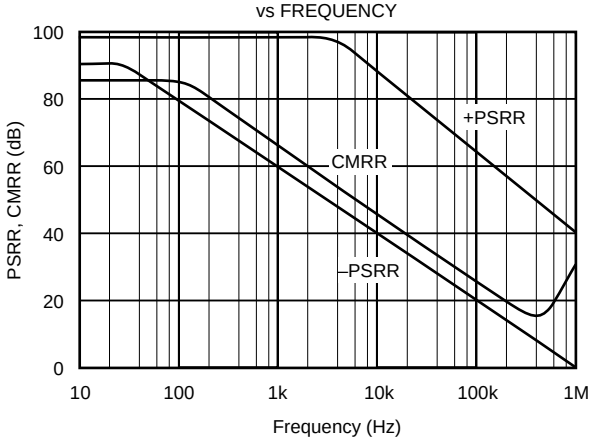
TYPICAL PERFORMANCE CURVES

At T_A = +25°C, V_S = ±15V, R_L = 10kΩ, connected to ground, unless otherwise noted.

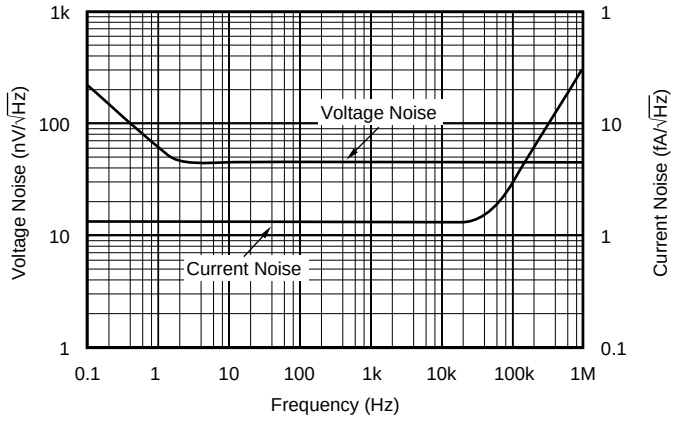
OPEN-LOOP GAIN/PHASE vs FREQUENCY



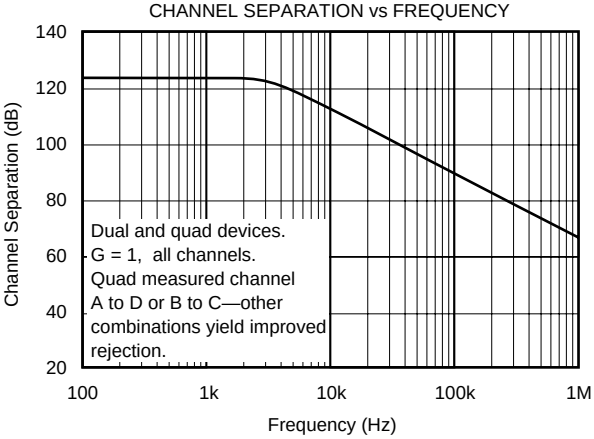
POWER SUPPLY AND COMMON-MODE REJECTION vs FREQUENCY



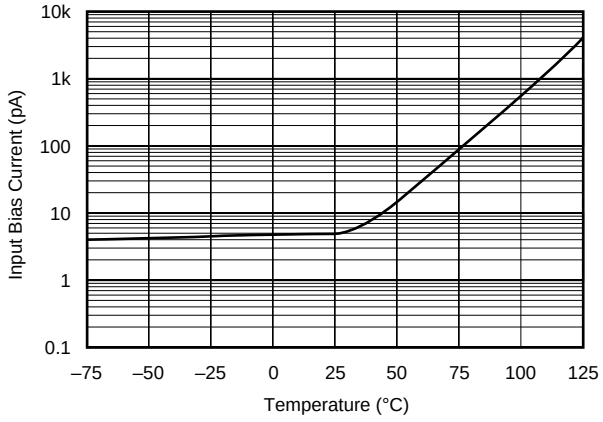
INPUT VOLTAGE AND CURRENT NOISE SPECTRAL DENSITY vs FREQUENCY



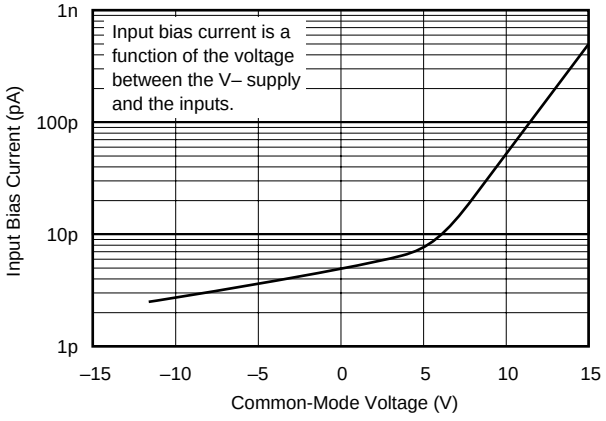
CHANNEL SEPARATION vs FREQUENCY



INPUT BIAS CURRENT vs TEMPERATURE



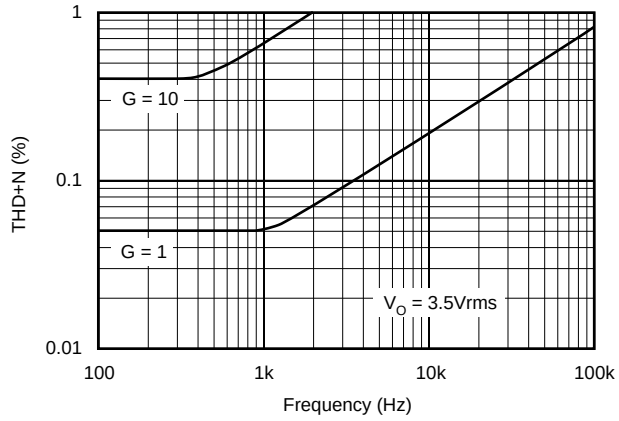
INPUT BIAS CURRENT vs INPUT COMMON-MODE VOLTAGE



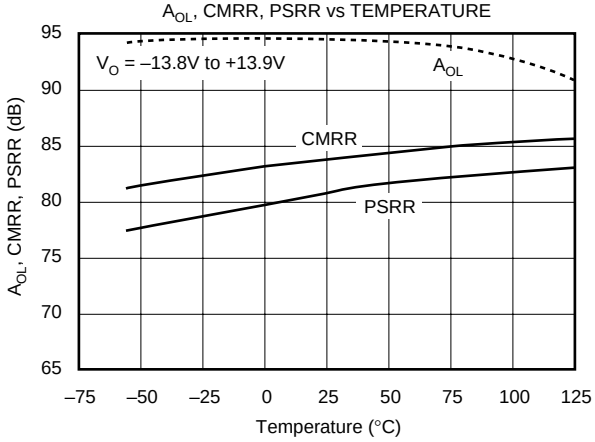
TYPICAL PERFORMANCE CURVES (CONT)

At T_A = +25°C, V_S = ±15V, R_L = 10kΩ, connected to ground, unless otherwise noted.

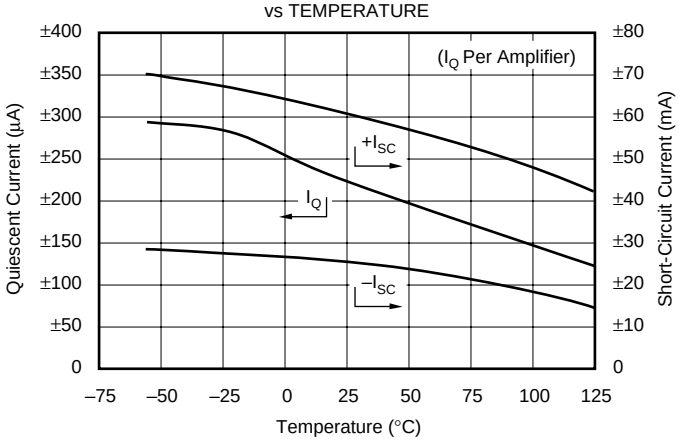
TOTAL HARMONIC DISTORTION + NOISE vs FREQUENCY



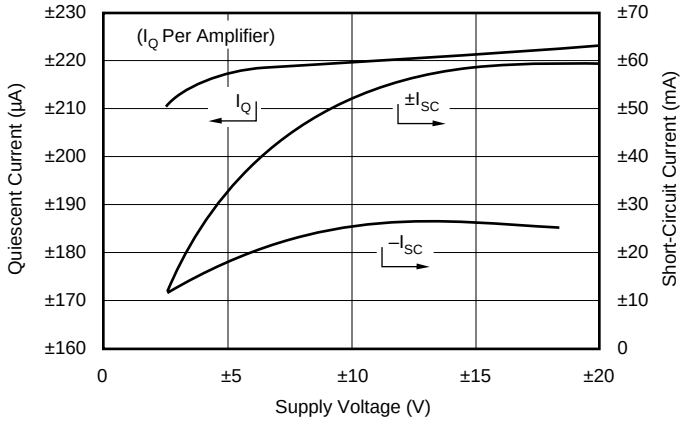
A_{OL}, CMRR, PSRR vs TEMPERATURE



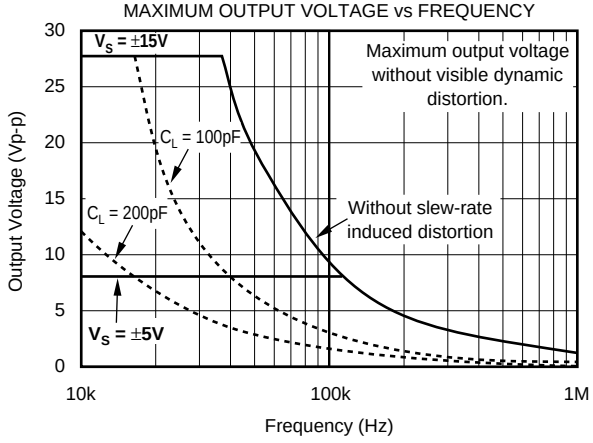
QUIESCENT CURRENT and SHORT-CIRCUIT CURRENT vs TEMPERATURE



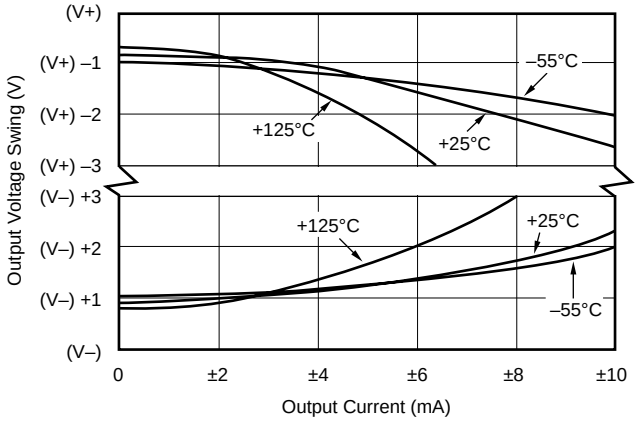
QUIESCENT CURRENT and SHORT-CIRCUIT CURRENT vs SUPPLY VOLTAGE



MAXIMUM OUTPUT VOLTAGE vs FREQUENCY



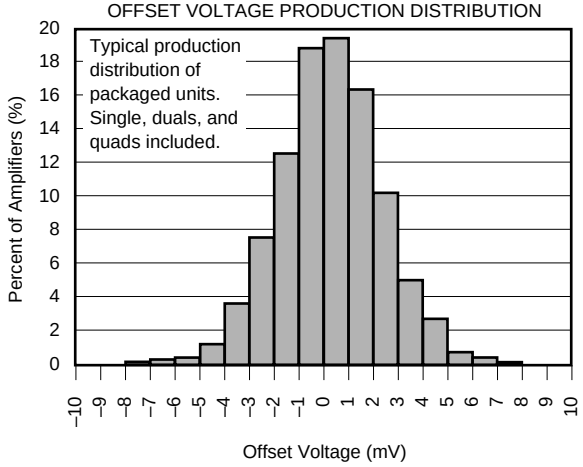
OUTPUT VOLTAGE SWING vs OUTPUT CURRENT



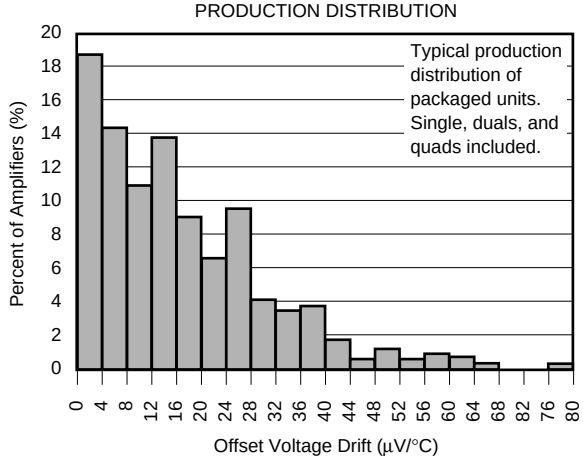
TYPICAL PERFORMANCE CURVES (CONT)

At T_A = +25°C, V_S = ±15V, R_L = 10kΩ, connected to ground, unless otherwise noted.

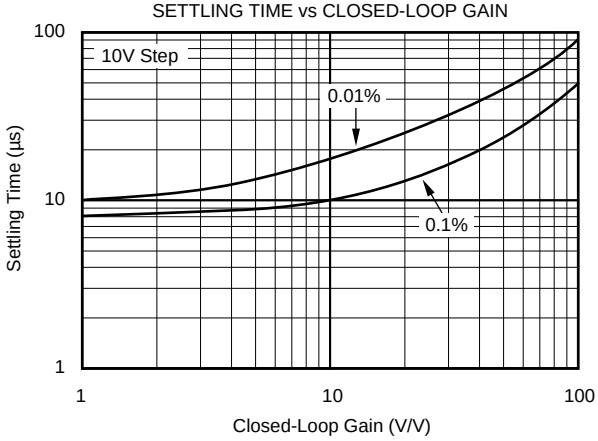
OFFSET VOLTAGE PRODUCTION DISTRIBUTION



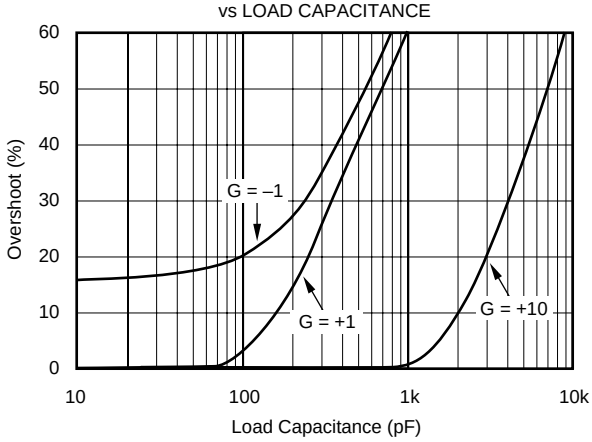
OFFSET VOLTAGE DRIFT PRODUCTION DISTRIBUTION



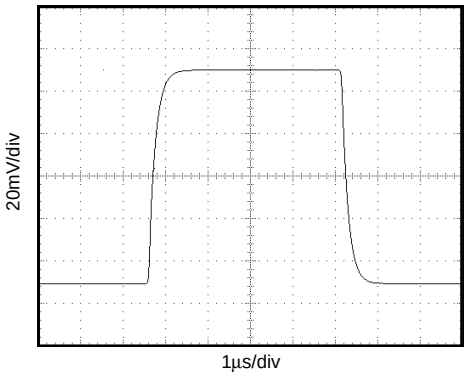
SETTLING TIME vs CLOSED-LOOP GAIN



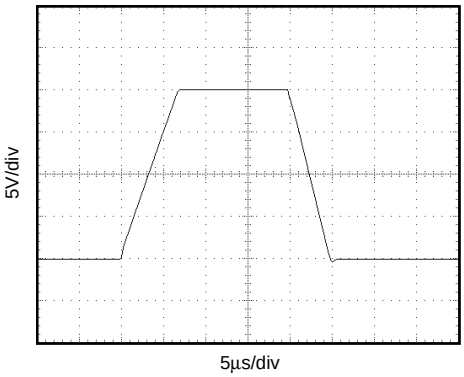
SMALL-SIGNAL OVERSHOOT vs LOAD CAPACITANCE



SMALL-SIGNAL STEP RESPONSE
G = 1, C_L = 50pF



LARGE-SIGNAL STEP RESPONSE
G = 1, C_L = 50pF



APPLICATIONS INFORMATION

OPA137 series op amps are unity-gain stable and suitable for a wide range of general-purpose applications. Power supply pins should be bypassed with 10nF ceramic capacitors or larger. All circuitry is completely independent in dual and quad versions, assuring normal performance when one amplifier in a package is overdriven or short circuited. Many key parameters are guaranteed over the specified temperature range, –40°C to +85°C.

OPERATING VOLTAGE

OPA137 op amps can be operated on power supplies as low as ±2.25V. Performance remains excellent with power supplies ranging from ±2.25V to ±18V (+4.5V to +36V single supply). Most parameters vary only slightly throughout this supply voltage range. Quiescent current and short-circuit current vs supply voltage are shown in Typical Performance Curves.

Operation at very low supply voltage ($V_S \leq \pm 3V$) requires careful attention to ensure that the common-mode voltage remains within the linear range, V_{CM} = (V–)+3V to (V+). Inputs may need to be biased above ground in accordance with the common-mode voltage range restrictions for linear operation.

INPUT VOLTAGE

The input common-mode voltage range of OPA137 series op amps extends from (V–)+3V to the positive rail, V+. For normal operation, inputs should be limited to this range. The inputs may go beyond the power supplies without output phase-reversal. Many FET-input op amps (such as TL061 types) exhibit phase-reversal of the output when the input common-mode range is exceeded. This can occur in voltage-follower circuits, causing serious problems in control loop applications.

Input terminals are diode-clamped to the power supply rails for ESD protection. If the input voltage can exceed the negative supply by 500mV, input current should be limited to 2mA (or less). If the input current is not adequately limited, you may see unpredicatable behavior in the other amplifiers in the package. This is easily accomplished with an input resistor as shown in Figure 1. Many input signals are inherently current-limited, therefore, a limiting resistor may not be required.

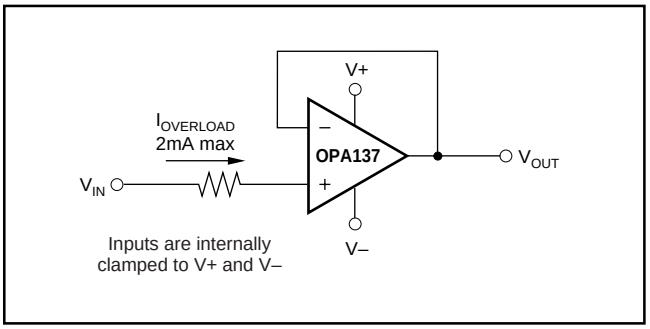


FIGURE 1. Input Current Protection for Voltages Exceeding the Supply Voltage.

HIGH-SIDE CURRENT SENSING

Many applications require the sensing of signals near the positive supply. The common-mode input range of OPA137 op amps includes the positive rail, enabling them to be used to sense power supply currents as shown in Figure 2.

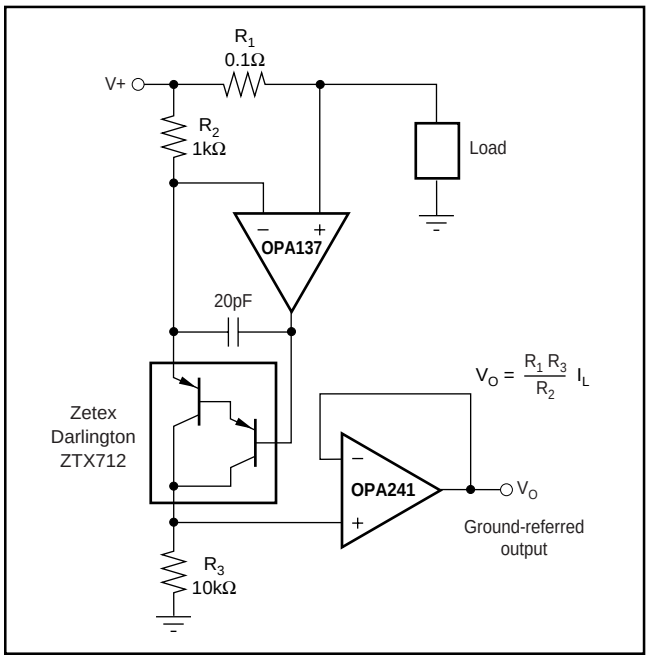


FIGURE 2. High-Side Current Monitor.

INPUT BIAS CURRENT

The input bias current is approximately 5pA at room temperature and increases with temperature as shown in the typical performance curve “Input Bias Current vs Temperature.”

Input Bias current also varies with common-mode voltage and power supply voltage. This variation is dependent on the voltage between the negative power supply and the common-mode input voltage. The effect is shown in the typical performance curve “Input Bias Current vs Common-Mode Voltage.”

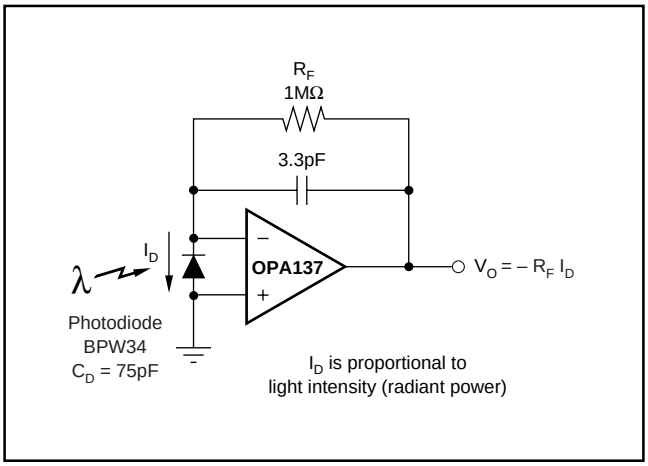
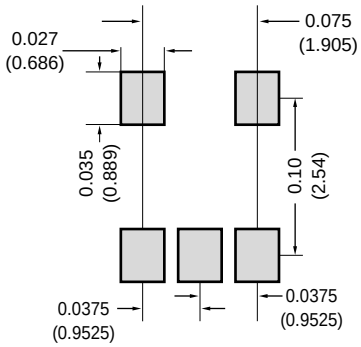
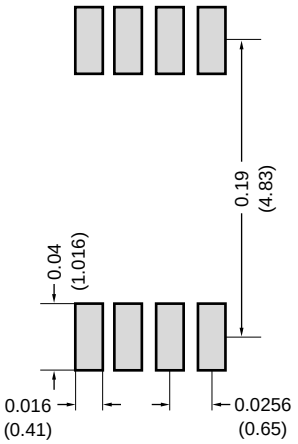


FIGURE 3. Photodetector Amplifier.

SOT-23-5
(Package Drawing #331)



MSOP-8
(Package Drawing #337)



Refer to end of data sheet or Appendix C of Burr-Brown Data Book for tolerances and detailed package drawing. For further information on solder pads for surface-mount devices consult Application Bulletin AB-132.

FIGURE 4. Recommended SOT-23-5 and MSOP-8 Solder Footprints.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
OPA137N/250	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137N/250E4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137N/3K	ACTIVE	SOT-23	DBV	5	3000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137N/3KE4	ACTIVE	SOT-23	DBV	5	3000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137NA/250	ACTIVE	SOT-23	DBV	5	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137NA/250E4	ACTIVE	SOT-23	DBV	5	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137NA/3K	ACTIVE	SOT-23	DBV	5	3000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137NA/3KE4	ACTIVE	SOT-23	DBV	5	3000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR
OPA137P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU SNPB	N / A for Pkg Type
OPA137PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU SNPB	N / A for Pkg Type
OPA137U	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA137UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA137UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA137UA/2K5G4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA137UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA137UE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137E/250	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137E/250G4	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137E/2K5	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137E/2K5G4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137EA/250	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137EA/250G4	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137EA/2K5	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137EA/2K5G4	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137P	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
OPA2137PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2137PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2137PG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA2137U	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137U/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137U/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137UA/2K5E4	PREVIEW	SOIC	D	8		TBD	Call TI	Call TI
OPA2137UAE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA2137UE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137P	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4137PA	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4137PAG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4137PG4	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
OPA4137U	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137U/2K5	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137U/2K5E4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UA	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UA/2K5	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UA/2K5G4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UAE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UAG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
OPA4137UE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

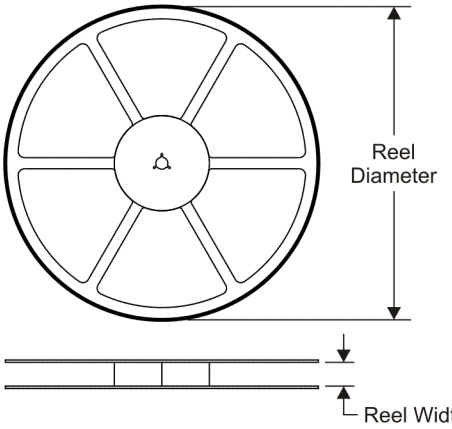
a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

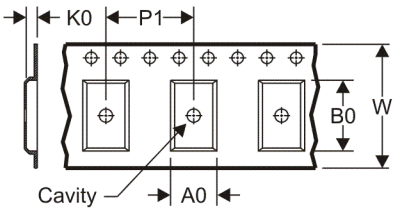
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

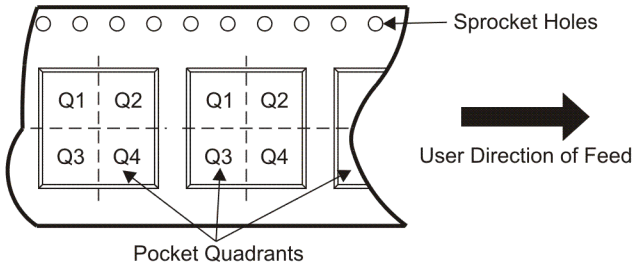


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

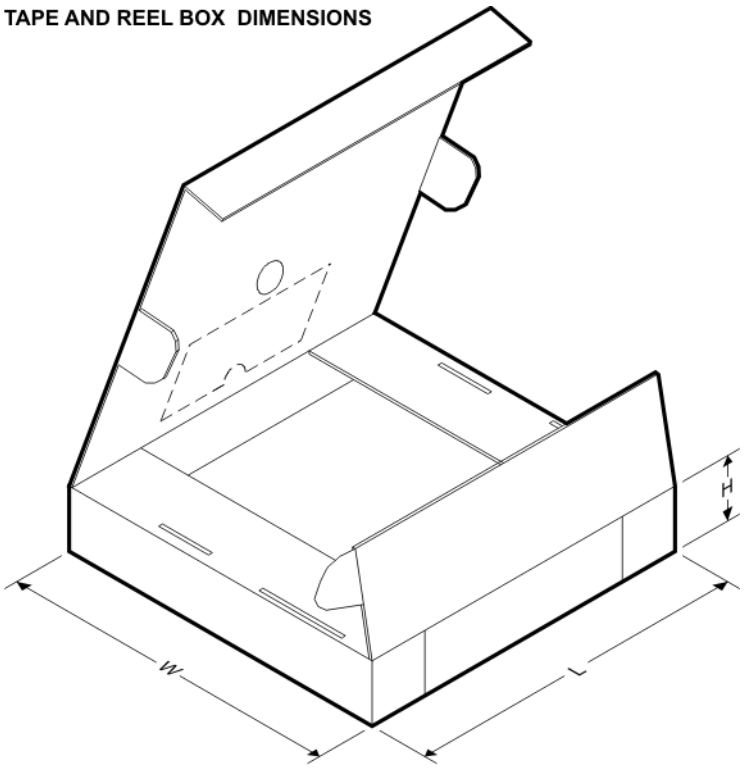
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA137N/250	SOT-23	DBV	5	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA137N/3K	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA137NA/250	SOT-23	DBV	5	250	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA137NA/3K	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.1	1.39	4.0	8.0	Q3
OPA137UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA2137E/250	MSOP	DGK	8	250	180.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2137E/2K5	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2137EA/250	MSOP	DGK	8	250	180.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2137EA/2K5	MSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2137U/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA2137UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4137U/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
OPA4137UA/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA137N/250	SOT-23	DBV	5	250	190.5	212.7	31.8
OPA137N/3K	SOT-23	DBV	5	3000	190.5	212.7	31.8
OPA137NA/250	SOT-23	DBV	5	250	190.5	212.7	31.8
OPA137NA/3K	SOT-23	DBV	5	3000	190.5	212.7	31.8
OPA137UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA2137E/250	MSOP	DGK	8	250	190.5	212.7	31.8
OPA2137E/2K5	MSOP	DGK	8	2500	346.0	346.0	29.0
OPA2137EA/250	MSOP	DGK	8	250	190.5	212.7	31.8
OPA2137EA/2K5	MSOP	DGK	8	2500	346.0	346.0	29.0
OPA2137U/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA2137UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0
OPA4137U/2K5	SOIC	D	14	2500	346.0	346.0	33.0
OPA4137UA/2K5	SOIC	D	14	2500	346.0	346.0	33.0

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Broadband	www.ti.com/broadband
DSP	dsp.ti.com	Digital Control	www.ti.com/digitalcontrol
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Military	www.ti.com/military
Logic	logic.ti.com	Optical Networking	www.ti.com/opticalnetwork
Power Mgmt	power.ti.com	Security	www.ti.com/security
Microcontrollers	microcontroller.ti.com	Telephony	www.ti.com/telephony
RFID	www.ti-rfid.com	Video & Imaging	www.ti.com/video
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265